

µIPM⁼DIP

4.0Ω, 500V

Integrated Power Module for Small Appliance Motor Drive Applications

Description

IRSM505-025 and IRSM515-025 are 3-phase Integrated Power Modules (IPM) designed for advanced appliance motor drive applications such as energy efficient fans and pumps. These advanced IPMs offers a combination of low R_{DS(on)} Trench FREDFET technology and the industry benchmark half-bridge high voltage, rugged driver in a familiar package. The modules are optimized for low EMI characteristics.

IRSM505-025 includes temperature feedback while IRSM515-025 does not.

Features

- 500V 3-phase inverter including high voltage gate drivers
- Integrated bootstrap functionality
- Low 4.0Ω (max, 25°C) R_{DS(on)} Trench FREDFET
- Under-voltage lockout for all channels
- Matched propagation delay for all channels
- Temperature feedback via NTC (IRSM505-025 only)
- Optimized dV/dt for loss and EMI trade offs
- Open-source for single and leg-shunt current sensing
- 3.3V logic compatible and advanced input filter
- Driver tolerant to negative transient voltage (-Vs)
- Isolation 1900V_{RMS}, 1min
- RoHS Compliant
- Certified by UL File Number E252584





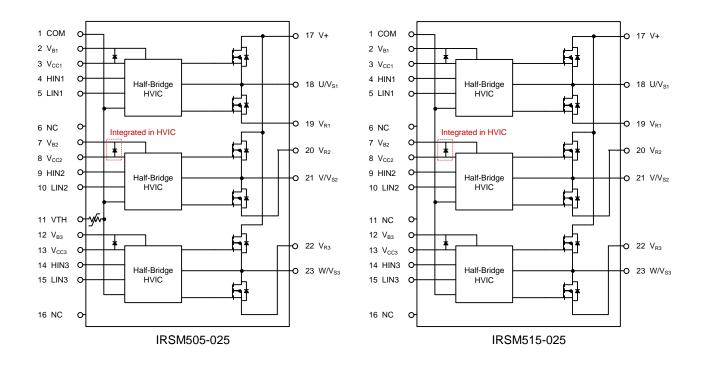
Base Part Number	NTC	Package Type	Standard Pac	k	Orderable Part Number
Dase Fait Nulliper	NIC		Form	Quantity	
		SOP23	Tube	240	IRSM505-025PA
IRSM505-025	Yes	DIP23	Tube	240	IRSM505-025DA
		DIP23A	Tube	240	IRSM505-025DA2
	No	SOP23	Tube	240	IRSM515-025PA
IDOME15 005		DIP23	Tube	240	IRSM515-025DA
IRSM515-025		DIP23A	Tube	240	IRSM515-025DA2
		DIP23C	Tube	240	IRSM515-025DA4

*i*MOTION[™]

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Internal Electrical Schematic



Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the module may occur. These are not tested at manufacturing. All voltage parameters are absolute voltages referenced to COM unless otherwise stated in the table.

Symbol	Description	Min	Max	Unit
BV _{DSS}	MOSFET Blocking Voltage		500	V
I ₀ @ T _C =25°C	DC Output Current per MOSFET		1.5	- A
I _{OP} @ T _C =25°C	Pulsed Output Current per MOSFET (Note 1)		11	A
P _d @ T _C =25°C	Maximum Power Dissipation per MOSFET		18	W
V _{ISO}	Isolation Voltage (1min)		1900	V _{RMS}
TJ	Operating Junction Temperature	-40	150	°C
T _C	Operating Case Temperature	-40	150	°C
Ts	Storage Temperature	-40	150	°C
V _{S1,2,3}	High Side Floating Supply Offset Voltage	V _{B1,2,3} - 20	V _{B1,2,3} +0.3	V
V _{B1,2,3}	High Side Floating Supply Voltage	-0.3	525	V
V _{CC}	Low Side and Logic Supply voltage	-0.3	25	V
V _{IN}	Input Voltage of LIN, HIN	COM -0.3	V _{CC} +0.3	V

Note 1: Pulse Width = 100µs, Single Pulse

2

Recommended Operating Conditions

Symbol	Description	Min	Max	Unit
V+	Positive DC Bus Input Voltage		400	V
V _{S1,2,3}	High Side Floating Supply Offset Voltage	(Note 2)	400	V
V _{B1,2,3}	High Side Floating Supply Voltage	V _S +12	V _S +20	V
V _{CC}	Low Side and Logic Supply Voltage	13.5	16.5	V
V _{IN}	Input Voltage of LIN, HIN, ITRIP, EN, FLT	0	5	V
F _p	PWM Carrier Frequency		20	kHz

Note 2: Logic operational for Vs from COM-8V to COM+500V. Logic state held for Vs from COM-8V to COM-V_{BS}.

Static Electrical Characteristics

 $(V_{CC}-COM) = (V_B-V_S) = 15 \text{ V}.$ $T_C = 25^{\circ}C$ unless otherwise specified. The V_{IN} and I_{IN} parameters are referenced to COM and are applicable to all six channels. The V_{CC_{UV}} parameters are referenced to COM. The V_{BS_{UV}} parameters are referenced to V_S.

Symbol	Description	Min	Тур	Max	Units	Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	500			V	T _J =25°C, Ι _{LK} =250μA
I _{LKH}	Leakage Current of High Side FET		12		μA	T _J =25°C, V _{DS} =500V
I _{LKL}	Leakage Current of Low Side FET Plus Gate Drive IC		14		μA	T _J =25°C, V _{DS} =500V
			3.0	4.0	Ω	T _J =25°C, V _{CC} =15V, Id=0.5A
R _{DS(on)}	Drain to Source ON Resistance		7.6		Ω	T _J =150°C, V _{CC} =15V, Id=0.5A (Note 3)
V _{SD}	Mosfet Body Diode Forward Voltage		0.8		V	T _J =25°C, V _{CC} =15V, I _D =0.5A
$V_{IN,th+}$	Positive Going Input Threshold	2.2			V	
V _{IN,th} -	Negative Going Input Threshold			0.8	V	
V _{CCUV+,} V _{BSUV+}	V_{CC} and V_{BS} Supply Under-Voltage, Positive Going Threshold	8	8.9	9.8	V	
V _{CCUV-,} V _{BSUV-}	V_{CC} and V_{BS} supply Under-Voltage, Negative Going Threshold	6.9	7.7	8.5	V	
V _{CCUVH,} V _{BSUVH}	V _{CC} and V _{BS} Supply Under-Voltage Lock-Out Hysteresis		1.2		V	
I _{QBS}	Quiescent V _{BS} Supply Current V _{IN} =0V		42	60	μΑ	
IQBS, ON	Quiescent V _{BS} Supply Current V _{IN} =4V		42	60	μA	
IQCC	Quiescent V_{CC} Supply Current $V_{IN}=0V$		1.7	4	mA	
I _{QCC, ON}	Quiescent V_{CC} Supply Current V_{IN} =4V		1.8	4	mA	
I _{IN+}	Input Bias Current V _{IN} =4V		5.9	18	μA	V _{IN} =3.3V
I _{IN-}	Input Bias Current V _{IN} =0V			2	μA	V _{IN} =0V
R _{BR}	Internal Bootstrap Equivalent Resistor Value		250		Ω	T _J =25°C

Note 3: Characterized, not tested at manufacturing

3

Dynamic Electrical Characteristics

 $(V_{CC}$ -COM) = $(V_B$ -V_S) = 15 V. T_C = 25^oC unless otherwise specified.

Symbol	Description	Min	Тур	Max	Units	Conditions	
T _{ON}	Input to Output Propagation Turn-On Delay Time		0.8	1.5	μs	I _D =120mA, V+=30V	
T _{OFF}	Input to Output Propagation Turn-Off Delay Time		0.9	1.5	μs	See Fig.1	
T _{FIL,IN}	Input Filter Time (HIN, LIN)	200	300		ns	V _{IN} =0 & V _{IN} =3.3V	
DT	Deadtime Inserted		400		ns	V _{IN} =0 & V _{IN} =3.3V without external deadtime	
Eon	Turn-on switching energy loss		25		μJ		
EOFF	Turn-off switching energy loss		5		μJ	V ₊ =320V, I _D =0.5A, L=40mH, T _C =25°C (Note 4)	
E _{REC}	Recovery energy loss		5		μJ		
E _{ON,150}	Turn-on switching energy loss		42		μJ		
E _{OFF,150}	Turn-off switching energy loss		6		μJ	V ₊ =320V, I _D =0.5A, L=40mH, T _C =150°C (Note 4)	
E _{REC,150}	Recovery energy loss		10		μJ		

Note 4: Characterized, not tested at manufacturing

Thermal and Mechanical Characteristics

Symbol	Description	Min	Тур	Max	Units	Conditions
R _{th(J-C)}	Junction to Case Thermal Resistance		7.0		°C/W	High Side V-Phase Mosfet (Note 5)

Note 5: Characterized, not tested at manufacturing. Case temperature (T_c) point shown in Figure 2.

Internal NTC – Thermistor Characteristics (IRSM505-025 Only)

Symbol	Description	Min	Тур	Max	Units	Conditions
R ₂₅	Resistance		47		kΩ	T _C =25°C, ±5% tolerance
R ₁₂₅	Resistance		1.41		kΩ	T _C =125°C
В	B-constant (25-50°C)		4050		К	±2% tolerance (Note 6)
Temperatu	ire Range	-40		125	°C	

Note 6: See application notes for usage

Qualification Information⁺

Qualification Level		Industrial ^{††}
Moisture S	ensitivity Level	MSL3 ^{†††}
RoHS Com	pliant	Yes
UL Certifie	d	Yes – File Number E252584
ESD	Machine Model	Class B
ESD	Human Body Model	Class 2

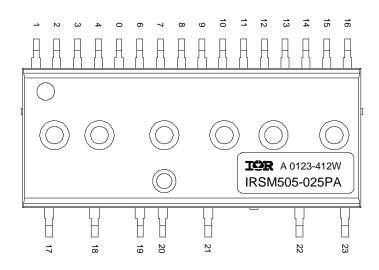
† Qualification standards can be found at International Rectifier's web site <u>http://www.irf.com/</u>

++ Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information.

+++ SOP23 package only. Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.

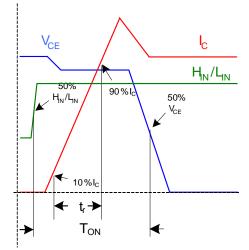
Module Pin-Out Description

Pin	Name	Description
1	COM	Logic Ground
2	V _{B1}	High Side Floating Supply Voltage 1
3	V _{CC1}	15V Supply 1
4	HIN1	Logic Input for High Side Gate Driver - Phase 1
5	LIN1	Logic Input for Low Side Gate Driver - Phase 1
6	NC	Not Connected
7	V _{B2}	High Side Floating Supply Voltage 2
8	V _{CC2}	15V Supply 2
9	HIN2	Logic Input for High Side Gate Driver - Phase 2
10	LIN2	Logic Input for Low Side Gate Driver - Phase 2
11	V _{TH}	Thermistor Output (IRSM505-025DA)
11	NC	Not Connected (IRSM515-025DA)
12	V _{B3}	High Side Floating Supply Voltage 3
13	V _{CC3}	15V Supply 3
14	HIN3	Logic Input for High Side Gate Driver - Phase 3
15	LIN3	Logic Input for Low Side Gate Driver - Phase 3
16	NC	Not Connected
17	V+	DC Bus Voltage Positive
18	U/V _{S1}	Output - Phase 1, High Side Floating Supply Offset 1
19	V _{R1}	Phase 1 Low Side Source
20	V _{R2}	Phase 2 Low Side Source
21	V/V _{S2}	Output - Phase 2, High Side Floating Supply Offset 2
22	V _{R3}	Phase 3 Low Side Source
23	W/V _{S3}	Output - Phase 3, High Side Floating Supply Offset 2





Referenced Figures



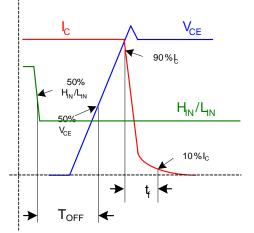


Figure 1a: Input to Output propagation turn-on delay time.

Figure 1b: Input to Output propagation turn-off delay time.

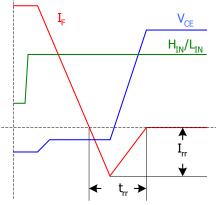
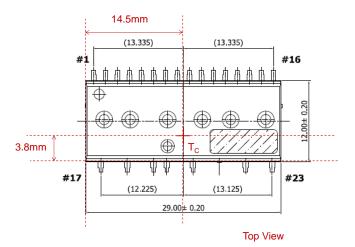


Figure 1c: Diode Reverse Recovery.









Application Notes

A basic application schematic is shown below.

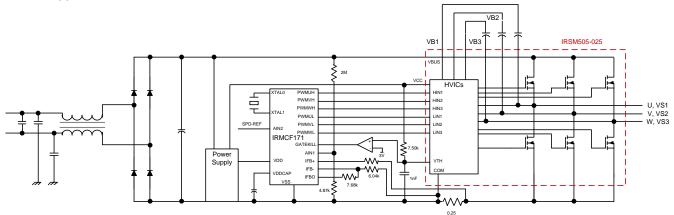


Figure 3: Basic sensor-less motor drive circuit connection. Motor is connected to U, V, W

A complete reference design board for running any permanent magnet motor via sensorless sinusoidal control is available. The board – photo below – features the µIPM[™]-DIP module and the iMotion[™] digital control IC. Reference design kits are available on the <u>International Rectifier website</u> (irf.com > Design Resources > Reference Designs > Intelligent Power Modules)



Figure 4: Reference design board featuring the µIPM™-DIP module and the iMotion™ IRMCF171 digital control IC





IRSM505-025 IRSM515-025 Series

Figures 5-7 show the typical current capability for this module at specified conditions. In all tests, the application board – the IRMCS1071-1-D reference board – was placed in a box to prevent cooling from ambient airflow. Figure 5 is derived from using a heat sink that maintains T_c at 125°C. Figures 6-7 represent current capability for the module as used without any heat sink. ΔT_{JA} represents the difference in temperature between the junction of the high-side V-phase Mosfet and the ambient, measured 10cm above and 6cm away from the board. Ambient temperature kept within 28-29°C.

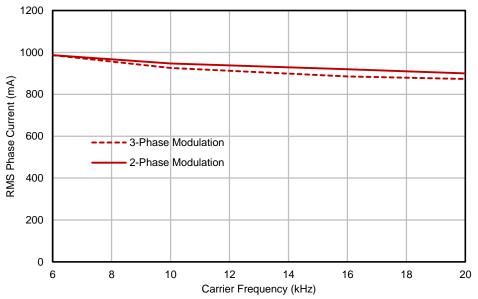
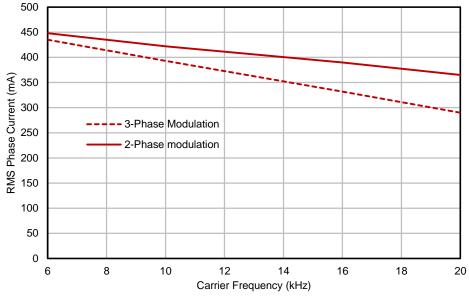
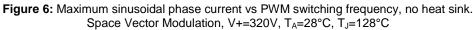
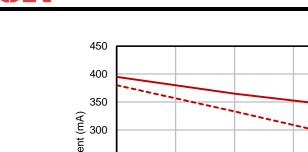


Figure 5: Maximum sinusoidal phase current vs PWM switching frequency with a heat sink. Space Vector Modulation, V+=320V, T_A=28°C, T_J=150°C, T_C=125°C





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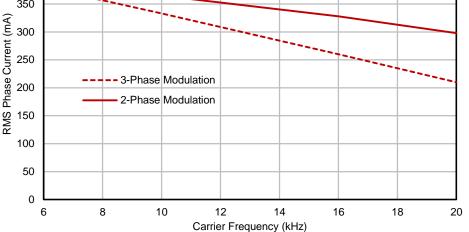


Figure 7: Maximum sinusoidal phase current vs PWM switching frequency, no heat sink. Space Vector Modulation, V+=320V, T_A=28°C, T_J=98°C

The module contains an NTC – connected between COM and the V_{TH} pin – which can be used to monitor the temperature of the module. The NTC is effectively a resistor whose value decreases as the temperature rises. The NTC resistance can be calculated at any temperature as follows:

$$R_{TH} = R_{25} e^{\left[B\left(\frac{1}{T_{TH}} - \frac{1}{T_{25}}\right)\right]}$$
 , where R_{25} is 47k Ω and B is 4050K

An external resistor network is connected to the NTC, the simplest of which is one resistor pulled up to V_{CC} as shown in Figure 3. The V_{TH} vs NTC temperature, T_{TH} curve for this configuration is shown in Figure 8 below. The min, typical and max curves result from the NTC having a ±5% tolerance on its resistance and ±2% tolerance on the B-parameter.

Figure 9 shows the thermistor temperature, T_{TH} plotted against the high-side V-phase junction temperature, T_J for a module without a heat sink. It is thus advisable to shut down the module when T_{TH} reaches 125°C.

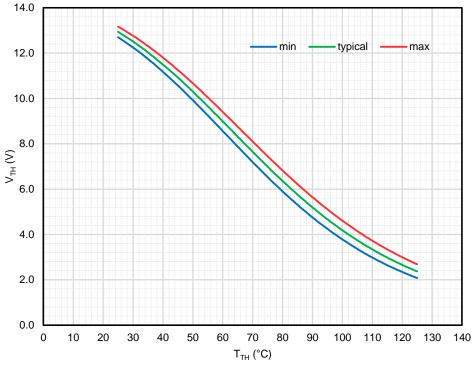
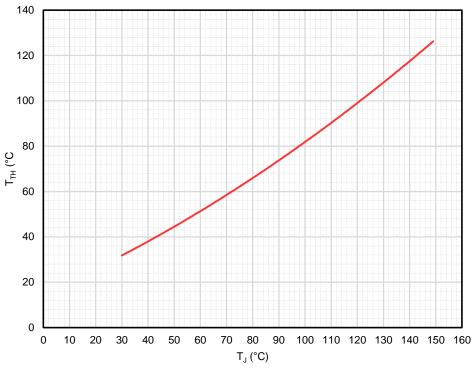
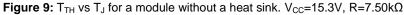


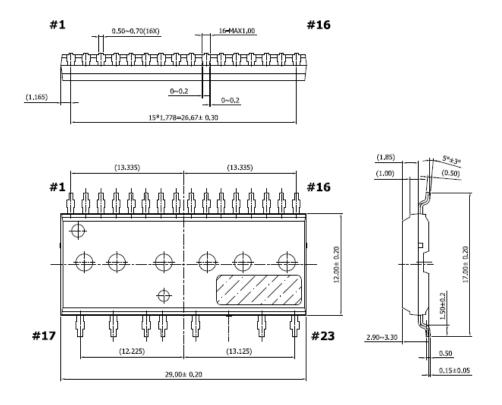
Figure 8: V_{TH} vs T_{TH} with V_{TH} pin pulled up to V_{CC} with a 7.50k Ω (1%, 100ppm) resistor. A 15V, 1% variation in V_{CC} is assumed.

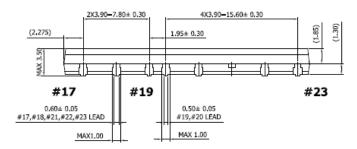






SOP23 Package Outline



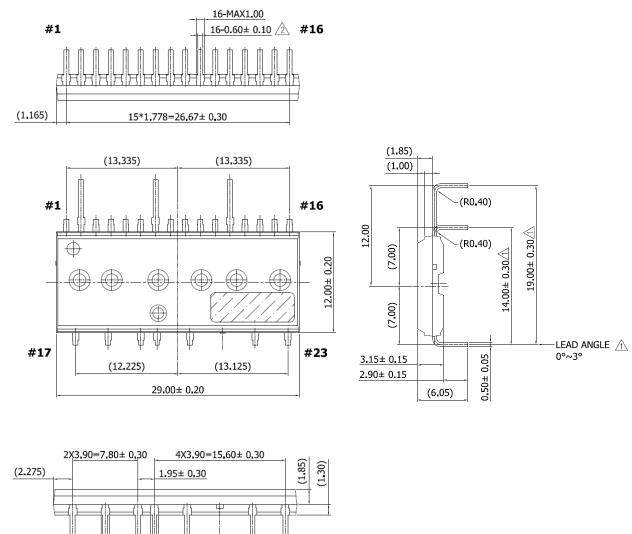


Dimensions in mm

*i*MOTION[™]



DIP23A Package Outline



#17 #19 #23 0.60± 0.05 #17,#18,#21,#22,#23 LEAD MAX1.00 MAX 1.00

Dimensions in mm



20~60

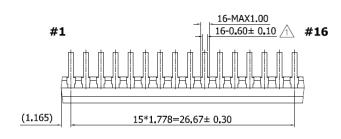
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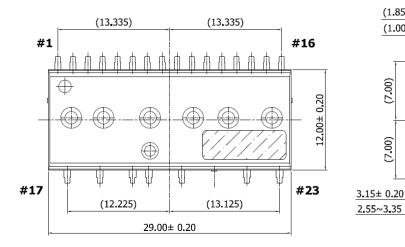
0.50± 0.05

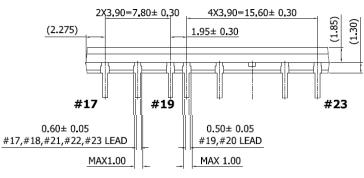
6.05± 0.20

14.55± 0.30

DIP23 Package Outline







Dimensions in mm

(1.85)

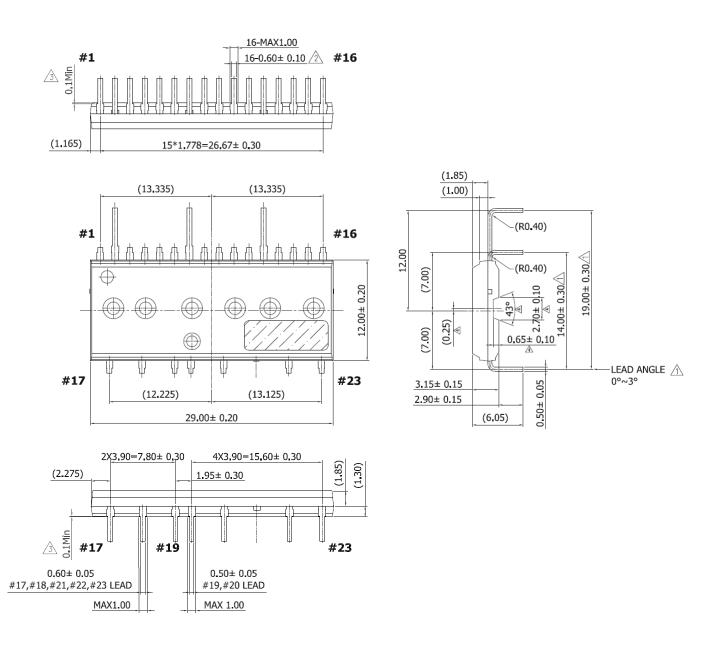
(1.00)

(7.00)

(7.00)



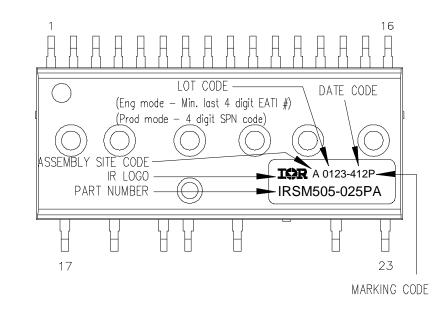
DIP23C Package Outline



Dimensions in mm



Top Marking



Marking Code P = Pb Free; Y = Engineering Samples **Date Code** YWW format, where Y = least significant digit of the production year, WW = two digits representing the week of the production year

Revision History

July 23, 2014	Corrected Figure 1, showing positive logic. Added DIP23C package option
Nov 0044	

Nov 2014 Added UL certification note





单击下面可查看定价,库存,交付和生命周期等信息

>>Infineon Technologies(英飞凌)